

TCR3DF series

300 mA CMOS Low Drop-Out Regulator with inrush current protection circuit

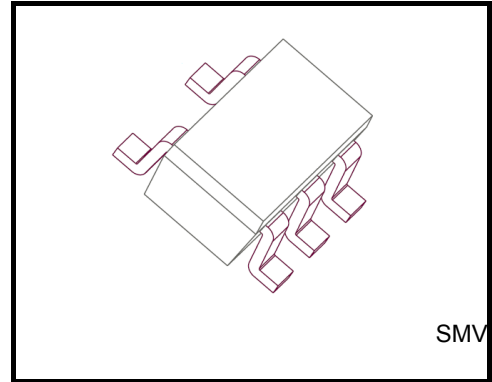
The TCR3DF series are CMOS general-purpose single-output voltage regulators with an on/off control input, featuring low dropout voltage, low output noise voltage and low inrush current.

These voltage regulators are available in fixed output voltages between 1.0 V and 4.5 V and capable of driving up to 300 mA.

They feature over-current protection, over-temperature protection, Inrush current protection circuit and Auto-discharge function.

The TCR3DF series has a low dropout voltage of 230 mV (2.5 V output, $I_{OUT} = 300$ mA) with low output noise voltage of $38 \mu V_{rms}$ (2.5 V output) and a load transient response of only $\Delta V_{OUT} = \pm 85$ mV ($I_{OUT} = 1$ mA \leftrightarrow 300 mA, $C_{OUT} = 1.0 \mu F$).

Thus, the TCR3DF series are suitable for sensitive power supply such as Analog and RF applications.



Weight :
SMV (SOT-25)(SC-74A) : 16 mg (typ.)

Features

- Low Drop-Out voltage
 - $V_{IN}-V_{OUT} = 230$ mV (typ.) at 2.5 V-output, $I_{OUT} = 300$ mA
 - $V_{IN}-V_{OUT} = 290$ mV (typ.) at 1.8 V-output, $I_{OUT} = 300$ mA
 - $V_{IN}-V_{OUT} = 510$ mV (typ.) at 1.2 V-output, $I_{OUT} = 300$ mA
- Low output noise voltage
 - $V_{NO} = 38 \mu V_{rms}$ (typ.) at 2.5 V-output, $I_{OUT} = 10$ mA, 10 Hz $\leq f \leq 100$ kHz
- Fast load transient response ($\Delta V_{OUT} = \pm 85$ mV (typ.) at $I_{OUT} = 1 \leftrightarrow 300$ mA, $C_{OUT} = 1.0 \mu F$)
- High ripple rejection (R.R = 70 dB (typ.) at 2.5V-output, $I_{OUT} = 10$ mA, $f = 1$ kHz)
- Over-current protection
- Over-temperature protection
- Inrush current protection circuit
- Auto-discharge function
- Pull down connection between CONTROL and GND
- Ceramic capacitors can be used ($C_{IN} = 1.0 \mu F$, $C_{OUT} = 1.0 \mu F$)
- General purpose package SMV(SOT-25) (SC-74A)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Input voltage	V_{IN}	6.0	V
Control voltage	V_{CT}	-0.3 to 6.0	V
Output voltage	V_{OUT}	-0.3 to $V_{IN} + 0.3$	V
Output current	I_{OUT}	300	mA
Power dissipation	P_D	200 (Note1)	mW
		580 (Note2)	
Operation temperature range	T_{opr}	-40 to 85	°C
Junction temperature	T_j	150	°C
Storage temperature range	T_{stg}	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

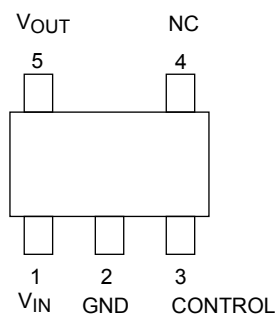
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Unit Rating

Note 2: Rating at mounting on a board
(FR4 board: 25.4 mm × 25.4 mm × 1.6 mm)

Pin Assignment (top view)

SMV(SOT-25)(SC-74A)



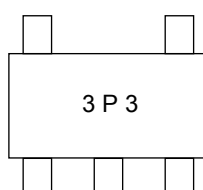
List of Products Number, Output voltage and Marking

Product No.	Output voltage(V)	Marking	Product No.	Output voltage(V)	Marking
TCR3DF10	1.0	1P0	TCR3DF275	2.75	2PF
TCR3DF105	1.05	1PA	TCR3DF28	2.8	2P8
TCR3DF11	1.1	1P1	TCR3DF285	2.85	2PD
TCR3DF12	1.2	1P2	TCR3DF29	2.9	2P9
TCR3DF125	1.25	1PC	TCR3DF295	2.95	2PE
TCR3DF13	1.3	1P3	TCR3DF30	3.0	3P0
TCR3DF15	1.5	1P5	TCR3DF31	3.1	3P1
TCR3DF17	1.7	1P7	TCR3DF32	3.2	3P2
TCR3DF18	1.8	1P8	TCR3DF33	3.3	3P3
TCR3DF185	1.85	1PF	TCR3DF335	3.35	3PD
TCR3DF19	1.9	1P9	TCR3DF36	3.6	3P6
TCR3DF24	2.4	2P4	TCR3DF39	3.9	3P9
TCR3DF25	2.5	2P5	TCR3DF40	4.0	4P0
TCR3DF27	2.7	2P7	TCR3DF45	4.5	4P5

Please ask your local retailer about the devices with other output voltages.

Top Marking (top view)

Example: TCR3DF33 (3.3 V output)



Electrical Characteristics

(Unless otherwise specified, $V_{IN} = V_{OUT} + 1\text{ V}$, $I_{OUT} = 50\text{ mA}$, $C_{IN} = 1.0\text{ }\mu\text{F}$, $C_{OUT} = 1.0\text{ }\mu\text{F}$, $T_j = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
Output voltage accuracy	V_{OUT}	$I_{OUT} = 50\text{ mA}$ (Note 3)	$V_{OUT} < 1.8\text{ V}$	-18	—	+18	mV
			$1.8\text{ V} \leq V_{OUT}$	-1.0	—	+1.0	%
Input voltage	V_{IN}	$I_{OUT} = 300\text{ mA}$	1.8	—	5.5	V	
Line regulation	Reg·line	$V_{OUT} + 0.5\text{ V} \leq V_{IN} \leq 5.5\text{ V}$, $I_{OUT} = 1\text{ mA}$	—	1	15	mV	
Load regulation	Reg·load	$1\text{ mA} \leq I_{OUT} \leq 300\text{ mA}$	—	30	50	mV	
Quiescent current	I_B	$I_{OUT} = 0\text{ mA}$	$V_{OUT} = 1.0\text{ V}$	—	65	—	μA
			$V_{OUT} = 1.8\text{ V}$	—	65	—	
			$V_{OUT} = 2.5\text{ V}$	—	68	—	
			$V_{OUT} = 4.5\text{ V}$	—	78	125	
Stand-by current	I_B (OFF)	$V_{CT} = 0\text{ V}$	—	0.1	1	μA	
Drop-out voltage	$V_{IN}-V_{OUT}$	$I_{OUT} = 300\text{ mA}$ (Note 4)	—	230	310	mV	
Temperature coefficient	T_{CVO}	$-40^\circ\text{C} \leq T_{opr} \leq 85^\circ\text{C}$	—	75	—	ppm/ $^\circ\text{C}$	
Output noise voltage	V_{NO}	$V_{IN} = V_{OUT} + 1\text{ V}$, $I_{OUT} = 10\text{ mA}$, $10\text{ Hz} \leq f \leq 100\text{ kHz}$, $T_a = 25^\circ\text{C}$ (Note 5)	—	38	—	μV_{rms}	
Ripple rejection ratio	R.R.	$V_{IN} = V_{OUT} + 1\text{ V}$, $I_{OUT} = 10\text{ mA}$, $f = 1\text{ kHz}$, $V_{Ripple} = 500\text{ mV}_{p-p}$, $T_a = 25^\circ\text{C}$ (Note 4)	—	70	—	dB	
Load transient response	ΔV_{OUT}	$I_{OUT} = 1 \leftrightarrow 300\text{ mA}$, $C_{OUT} = 1.0\text{ }\mu\text{F}$	—	± 85	—	mV	
Control voltage (ON)	V_{CT} (ON)	—	1.0	—	5.5	V	
Control voltage (OFF)	V_{CT} (OFF)	—	0	—	0.4	V	

Note 3: Stable state with fixed I_{OUT} condition.

Note 4: The 2.5 V output product.

Drop-out voltage

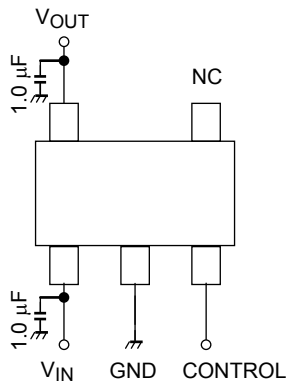
($I_{OUT} = 300\text{ mA}$, $C_{IN} = 1.0\text{ }\mu\text{F}$, $C_{OUT} = 1.0\text{ }\mu\text{F}$, $T_j = 25^\circ\text{C}$)

Output voltages	Symbol	Min	Typ.	Max	Unit
1.0 V, 1.05 V	$V_{IN}-V_{OUT}$	—	610	770	mV
1.1 V, 1.15 V		—	570	670	
1.2 V, 1.25 V		—	510	620	
1.3 V		—	470	570	
1.4 V		—	410	540	
$1.5\text{ V} \leq V_{OUT} < 1.8\text{ V}$		—	370	470	
$1.8\text{ V} \leq V_{OUT} < 2.1\text{ V}$		—	290	400	
$2.1\text{ V} \leq V_{OUT} < 2.5\text{ V}$		—	260	350	
$2.5\text{ V} \leq V_{OUT} < 2.8\text{ V}$		—	230	310	
$2.8\text{ V} \leq V_{OUT} < 3.2\text{ V}$		—	220	270	
$3.2\text{ V} \leq V_{OUT} < 3.6\text{ V}$		—	200	250	
$3.6\text{ V} \leq V_{OUT} \leq 4.5\text{ V}$		—	170	220	

Application Note

1. Recommended Application Circuit

●SMV



CONTROL voltage	Output voltage
HIGH	ON
LOW	OFF
OPEN	OFF

The figure above shows the recommended configuration for using a Low-Dropout regulator. Insert a capacitor at V_{OUT} and V_{IN} pins for stable input/output operation. (Ceramic capacitors can be used).

2. Power Dissipation

Both unit and board-mounted power dissipation ratings for TCR3DF series are available in the Absolute Maximum Ratings table.

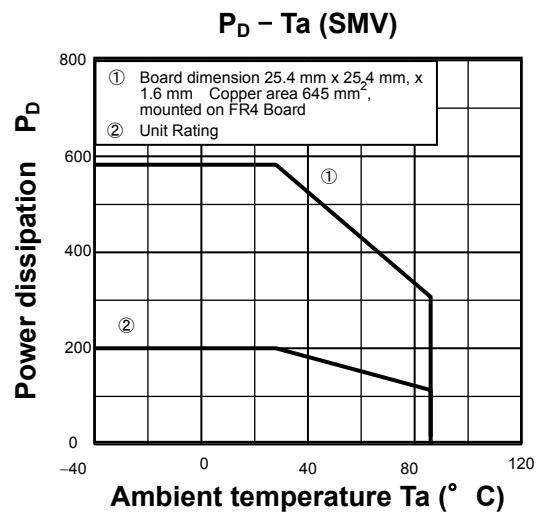
Power dissipation is measured on the board shown below.

Testing Board of Thermal Resistance

*Board material: FR4 board

Board dimension: 25.4 mm × 25.4 mm × 1.6 mm

Copper area: 645 mm²



Attention in Use

- **Output Capacitors**
Ceramic capacitors can be used for these devices. However, because of the type of the capacitors, there might be unexpected thermal features. Please consider application condition for selecting capacitors. And Toshiba recommend the ESR of ceramic capacitor is under 10 Ω .

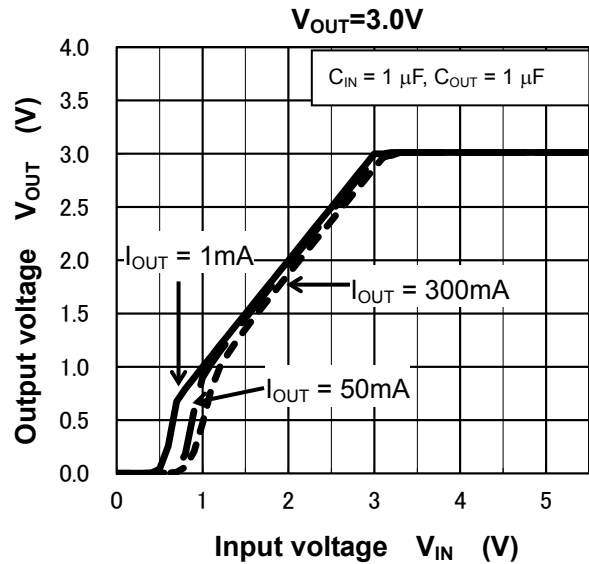
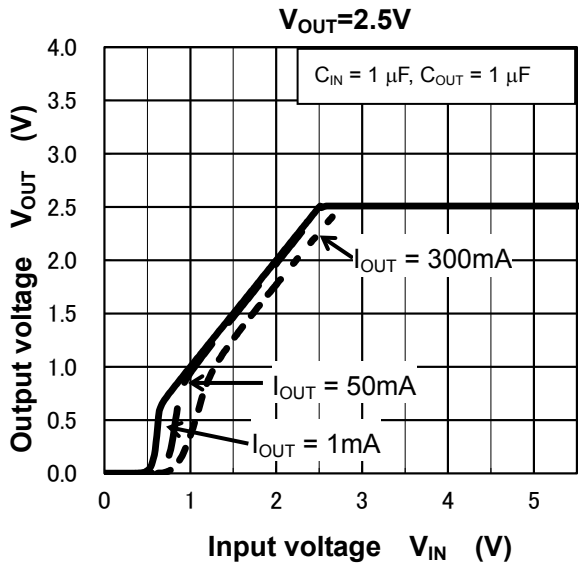
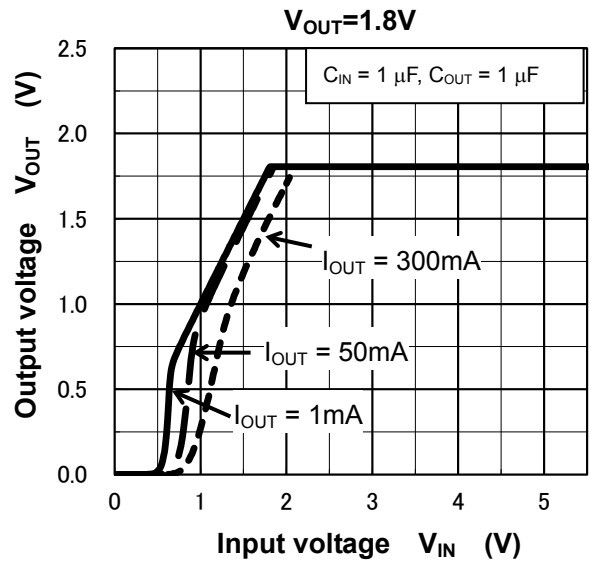
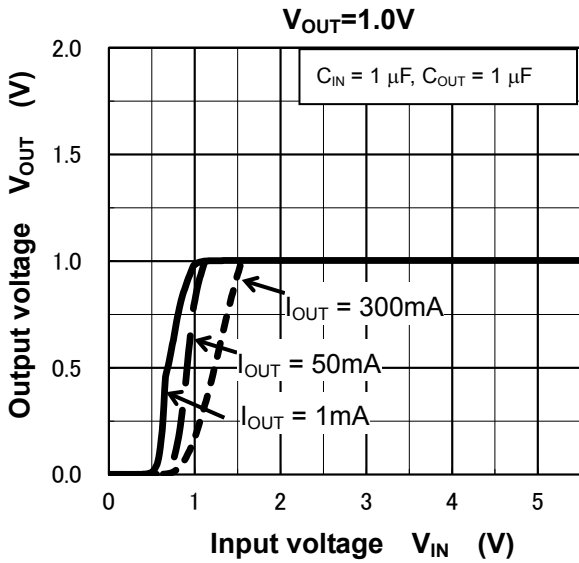
- **Mounting**
The long distance between IC and output capacitor might affect phase assurance by impedance in wire and inductor. For stable power supply, output capacitor need to mount near IC as much as possible. Also VIN and GND pattern need to be large and make the wire impedance small as possible.

- **Permissible Loss**
Please have enough design patterns for expected maximum permissible loss. And under consideration of surrounding temperature, input voltage, and output current etc, we recommend proper dissipation ratings for maximum permissible loss; in general maximum dissipation rating is 70 to 80 percent.

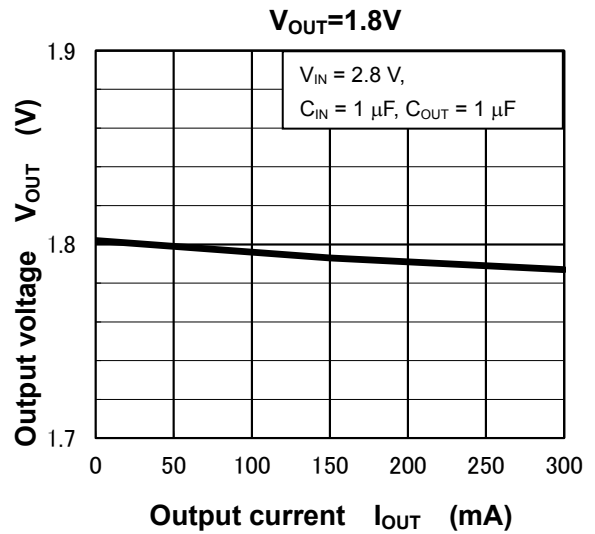
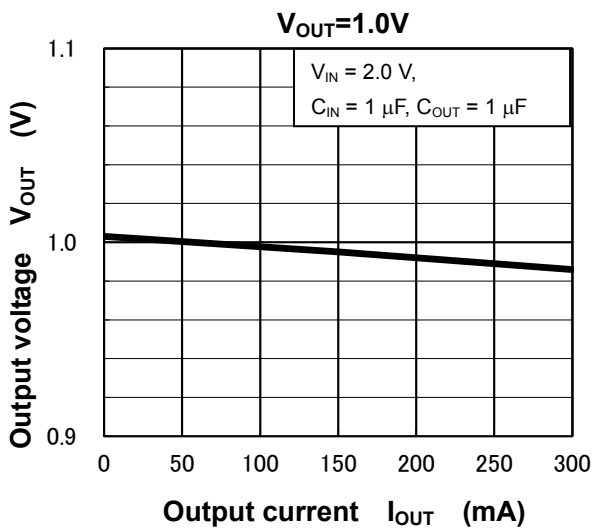
- **Over current Protection and Thermal shut down function**
Over current protection and Thermal shut down function are designed in these products, but these are not designed to constantly ensure the suppression of the device within operation limits. Depending on the condition during actual usage, it could affect the electrical characteristic specification and reliability. Also note that if output pins and GND pins are not completely shorted out, these products might be break down.
When using these products, please read through and understand the concept of dissipation for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommend inserting failsafe system into the design.

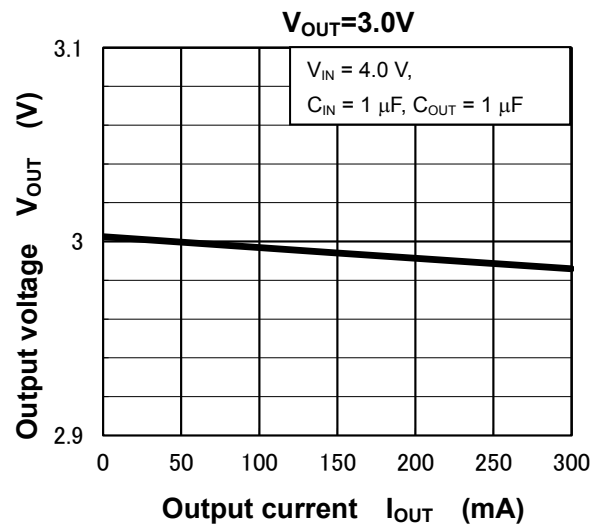
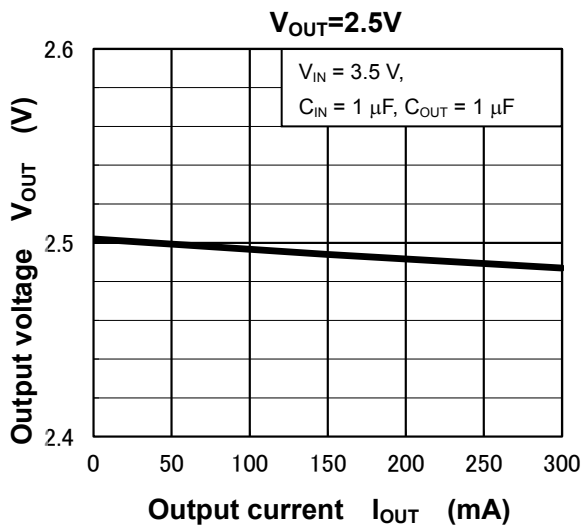
Representative Typical Characteristics

Output Voltage vs. Input Voltage

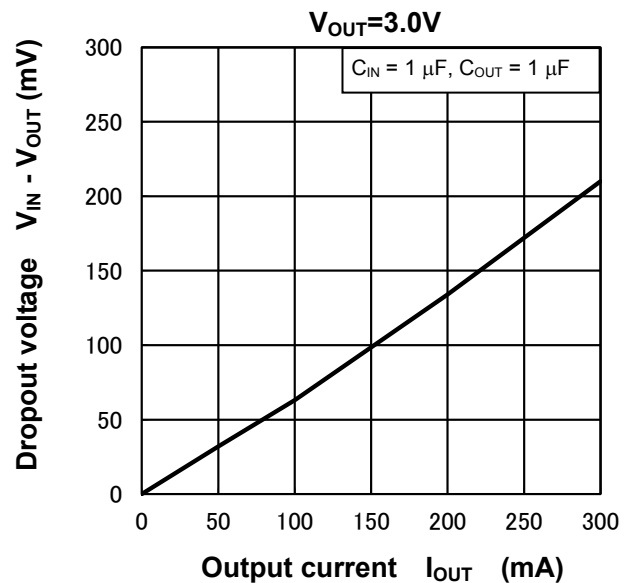
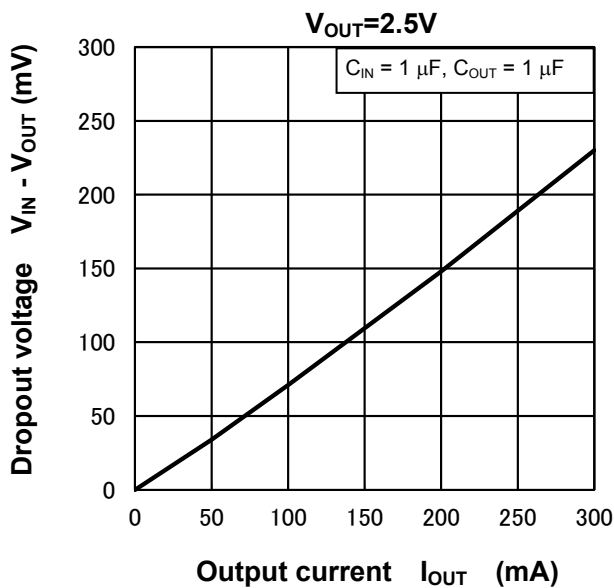
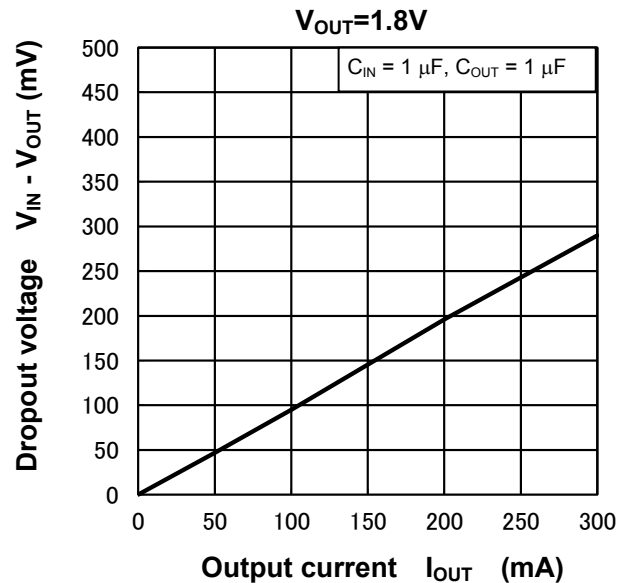
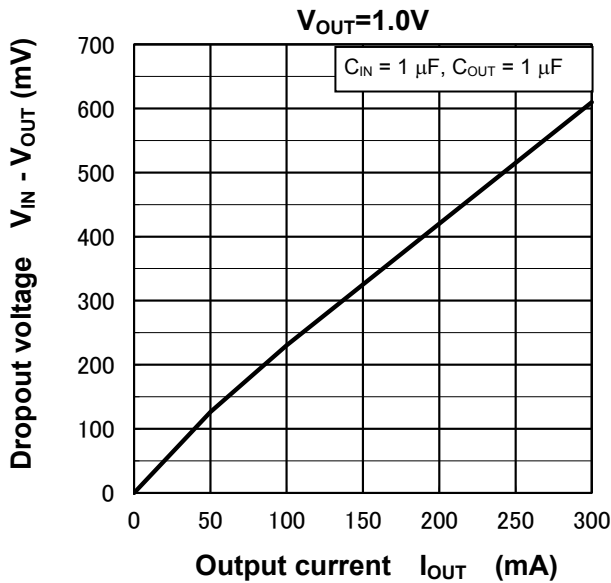


Output Voltage vs. Output Current

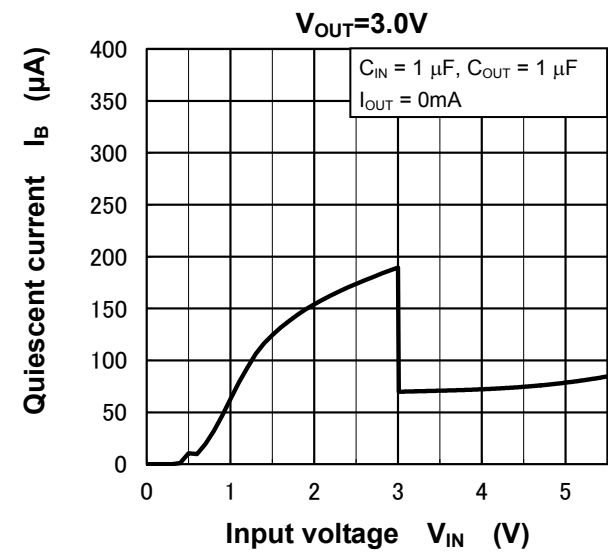
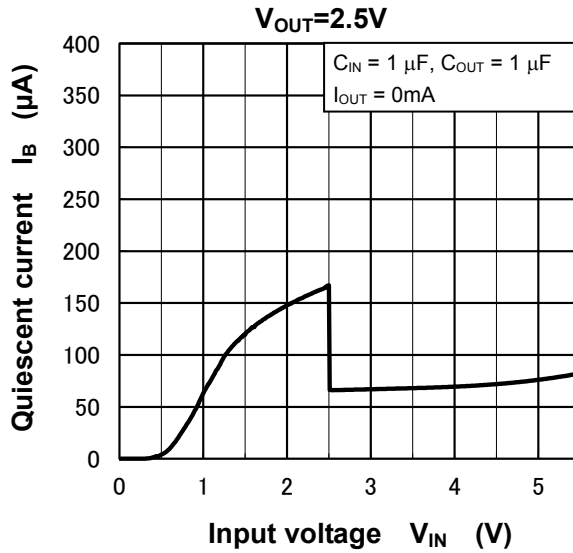
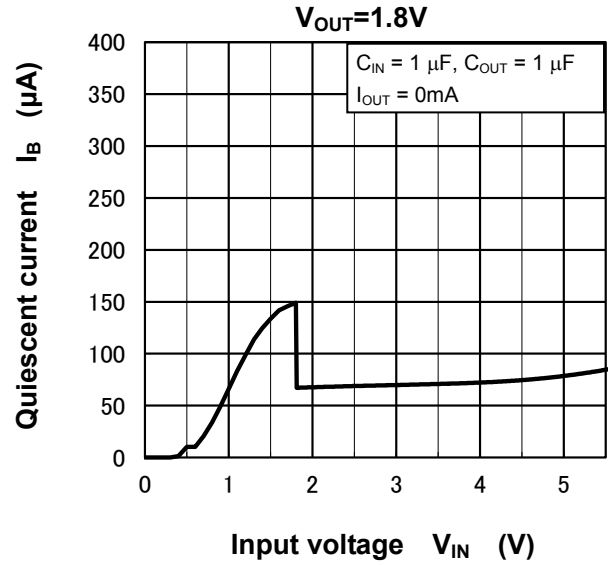
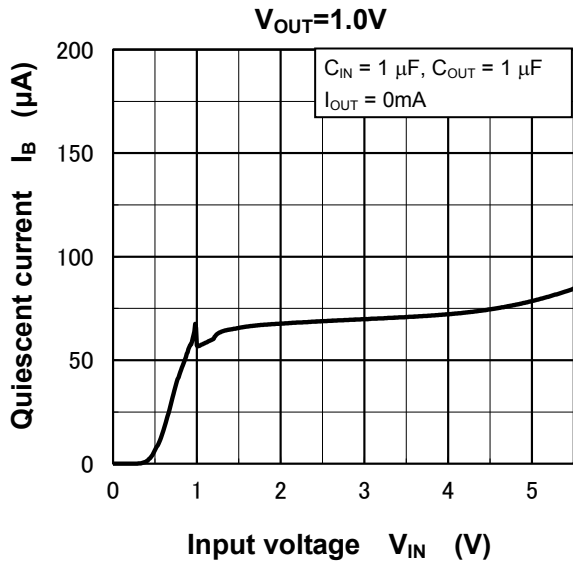




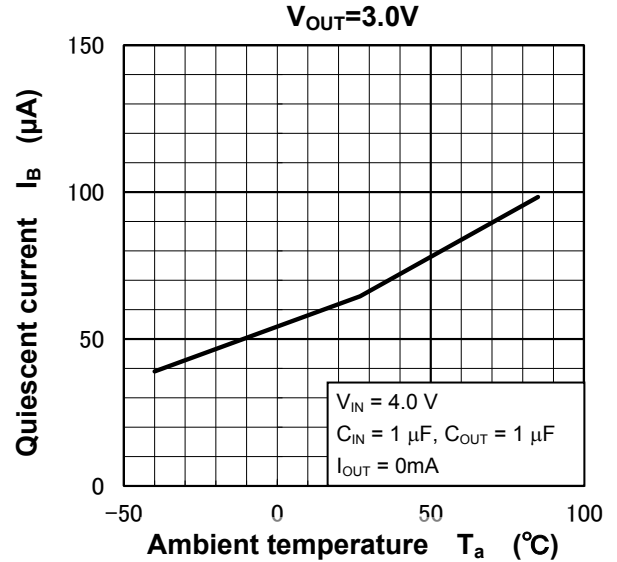
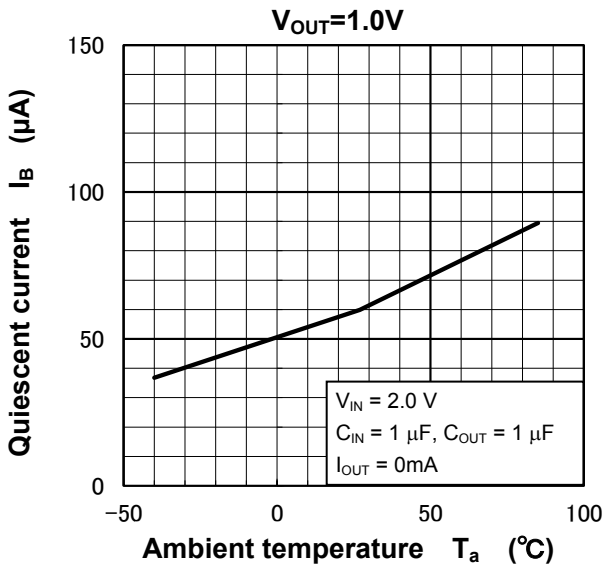
Dropout Voltage vs. Output Current



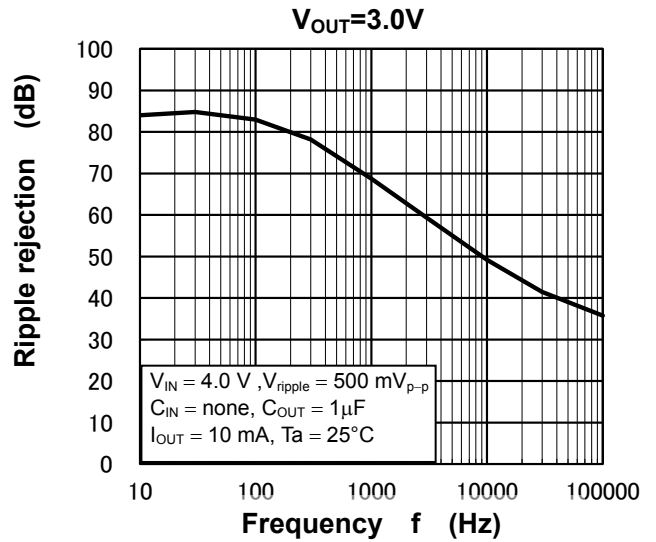
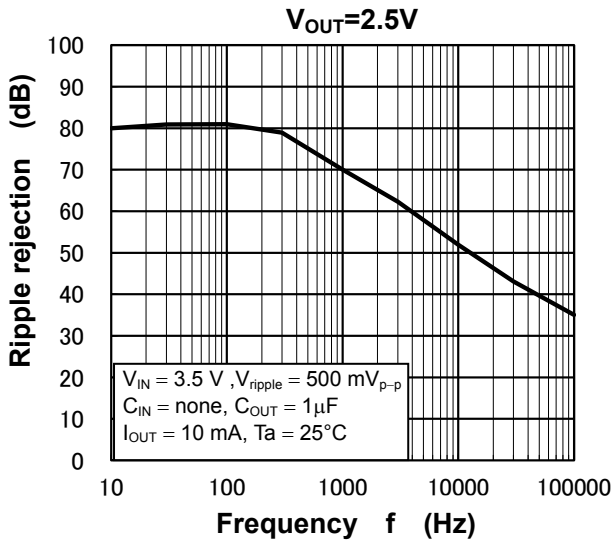
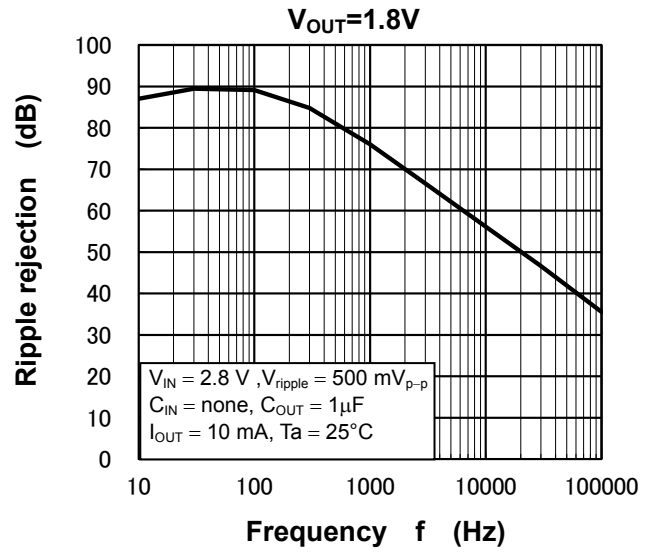
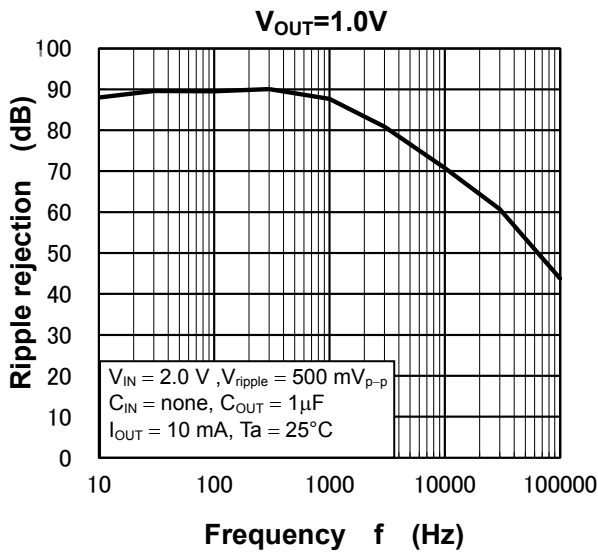
Quiescent Current vs. Input Voltage



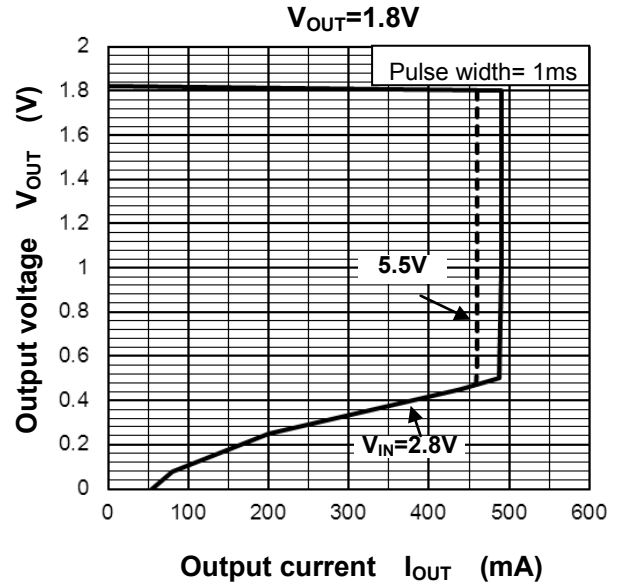
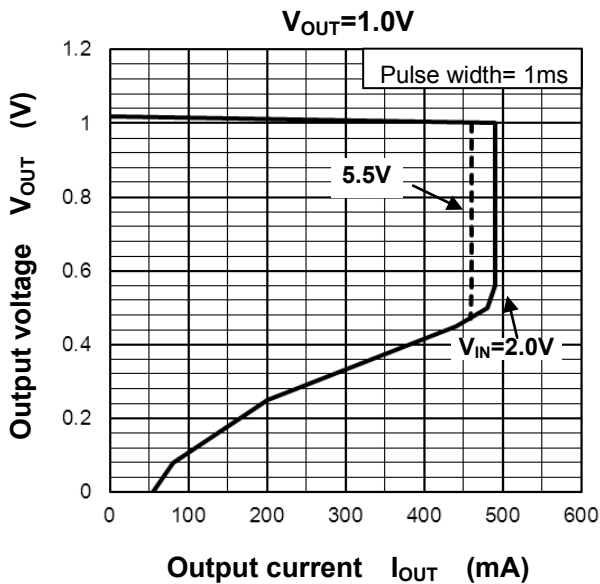
Quiescent Current vs. Ambient Temperature

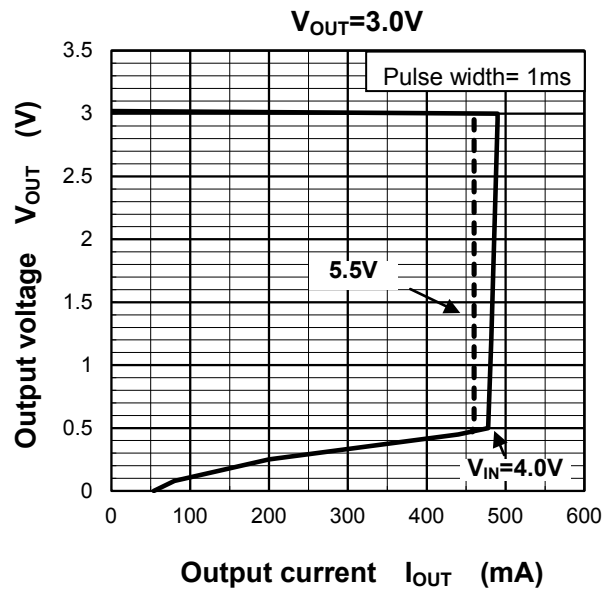
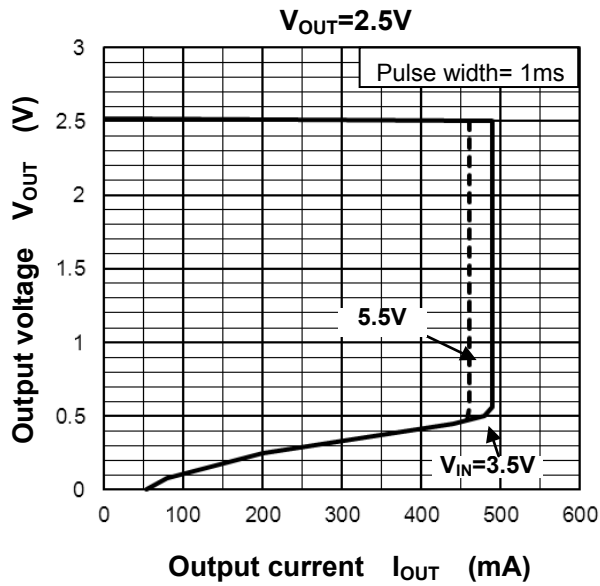


Ripple Rejection Ratio vs. Frequency

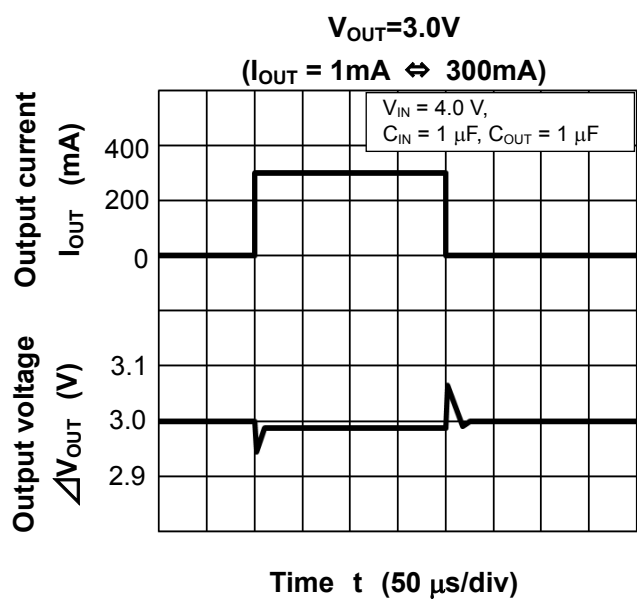
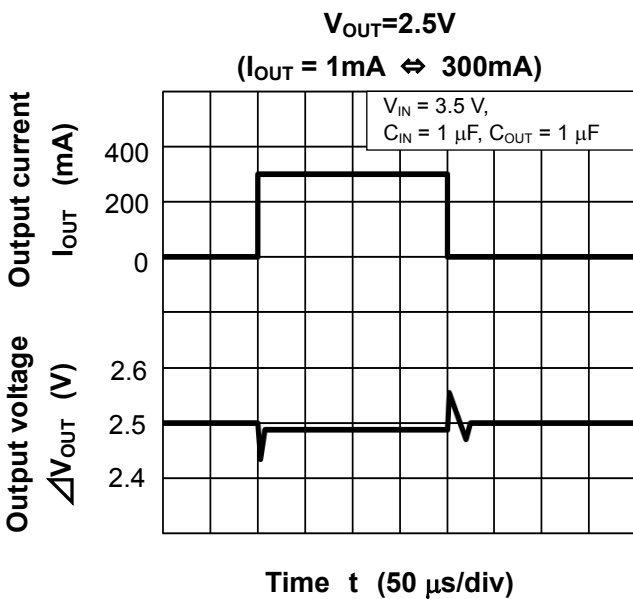
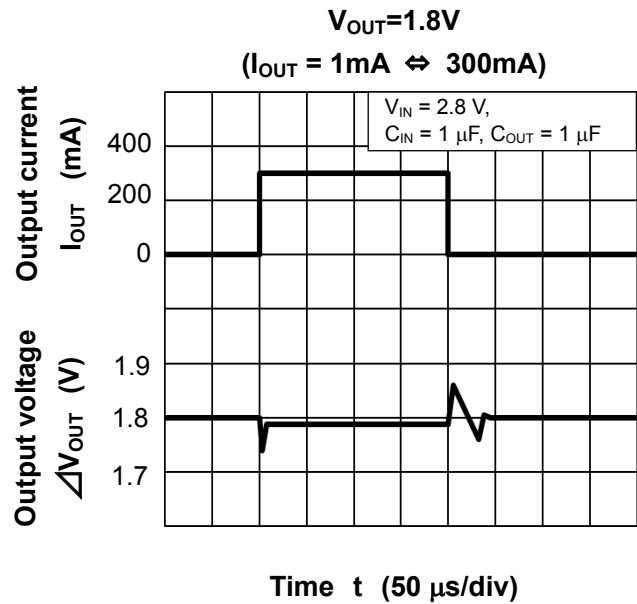
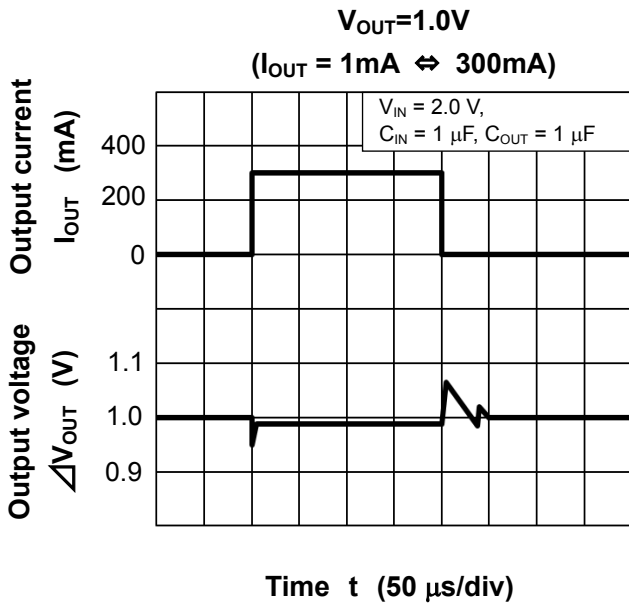


Output Voltage vs. Output Current

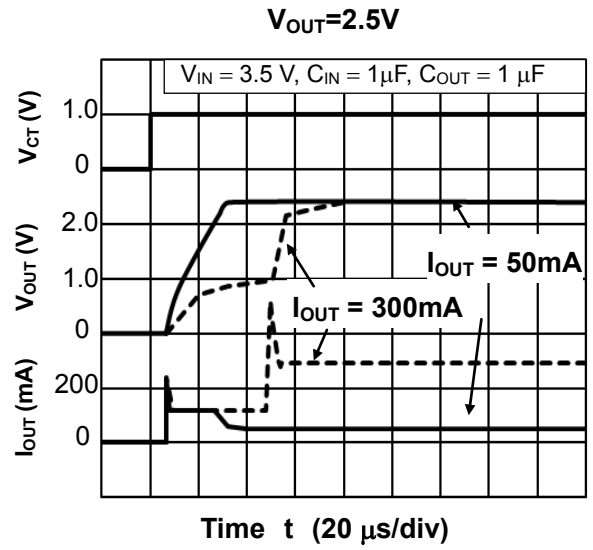
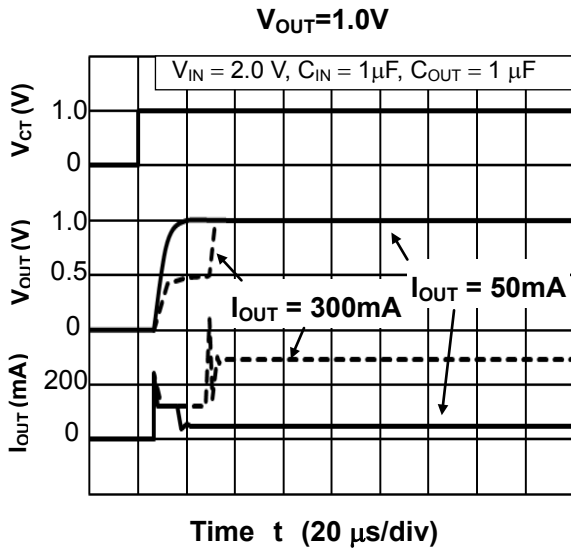




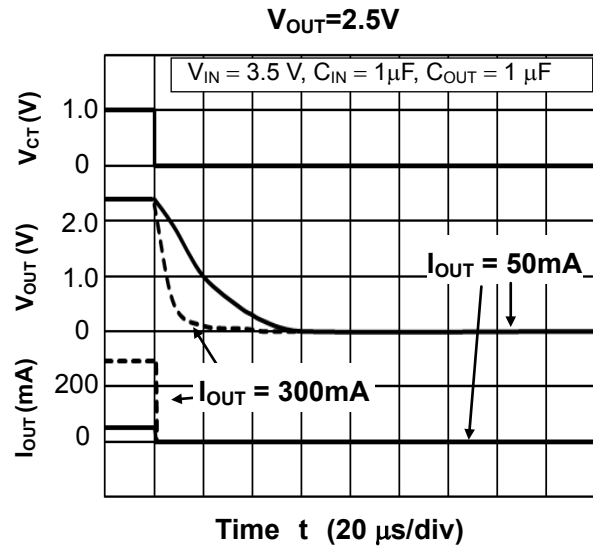
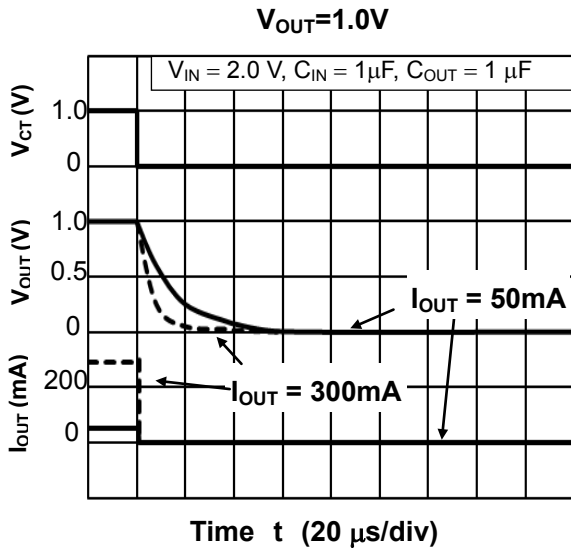
Load Transient Response



t_{ON} Response



t_{OFF} Response





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